

### **MOSFET**

### OptiMOS<sup>™</sup>5 Power-Transistor, 150 V

#### **Features**

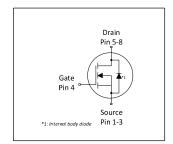
- Ideal for high frequency switching and synchronous rectification
   Optimized technology for DC/DC converters
   Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
   Very low on-resistance R<sub>DS(on)</sub>

- N-channel, normal level
- 100% avalanche tested
- Pb-free plating; RoHS compliant
  Qualified according to JEDEC<sup>1)</sup> for target applications
  Halogen-free according to IEC61249-2-21
- Higher solder joint reliability with enlarged source interconnection

Table 1 **Key Performance Parameters** 

- a.c							
Parameter	Value	Unit					
V <sub>DS</sub>	150	V					
R <sub>DS(on),max</sub>	30	m $Ω$					
I <sub>D</sub>	32	A					
Qrr	10.9	nC					











Type / Ordering Code	Package	Marking	Related Links
BSZ300N15NS5	PG-TSDSON-8 FL	300N15N	-



### **Table of Contents**

scription
aximum ratings
ermal characteristics
ectrical characteristics
ectrical characteristics diagrams
ckage Outlines S
vision History
ademarks
sclaimer



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 **Maximum ratings** 

Dougnoston	Comple al		Values			N ( 7 ( 0 ) 1111	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current	I <sub>D</sub>	-	-	32 21	А	T <sub>C</sub> =25 °C T <sub>C</sub> =100 °C	
Pulsed drain current <sup>1)</sup>	I <sub>D,pulse</sub>	-	-	128	Α	T <sub>C</sub> =25 °C	
Avalanche energy, single pulse <sup>2)</sup>	E <sub>AS</sub>	-	-	30	mJ	$I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 $\Omega$	
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-	
Power dissipation	P <sub>tot</sub>	-	-	62.5	W	T <sub>C</sub> =25 °C	
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56	

#### 2 Thermal characteristics

Table 3 Thermal characteristics

Davamatav	Cumb al		Values		11:4	Note / Took Condition	
Parameter	Symbol	Min. Typ. Max.		Unit	Note / Test Condition		
Thermal resistance, junction - case	$R_{thJC}$	-	1.2	2	K/W	-	
Device on PCB, 6 cm <sup>2</sup> cooling area <sup>3)</sup>	$R_{thJA}$	-	-	60	K/W	-	

#### **Electrical characteristics**

at T<sub>j</sub>=25 °C, unless otherwise specified

Table 4 **Static characteristics** 

Davamatar	Cymph al	Values			11::4	Nata / Tast Canditian	
Parameter	Symbol	Min.	Typ.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	150	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.8	4.6	V	$V_{DS}$ = $V_{GS}$ , $I_D$ =32 μA	
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μΑ	V <sub>DS</sub> =120 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =120 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C	
Gate-source leakage current	I <sub>GSS</sub>	-	1	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	25.5 28.1	30 49	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =16 A V <sub>GS</sub> =8 V, I <sub>D</sub> =8 A	
Gate resistance <sup>4)</sup>	R <sub>G</sub>	0.4	0.8	1.2	Ω	-	
Transconductance	$g_{fs}$	11	22	-	nC		

<sup>1)</sup> See Diagram 3 for more detailed information

<sup>&</sup>lt;sup>2)</sup> See Diagram 13 for more detailed information
<sup>3)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for drain connection.



Table 5 Dynamic characteristics

Parameter.	Coursello a I		Values			Nata / Tank Oak Alifting	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance <sup>1)</sup>	Ciss	-	730	950	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, f=1 MHz	
Output capacitance <sup>1)</sup>	Coss	-	180	230	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, f=1 MHz	
Reverse transfer capacitance <sup>1)</sup>	Crss	-	6	11	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, <i>f</i> =1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	7.0	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =16 A, $R_{\rm G,ext}$ =3 $\Omega$	
Rise time	t <sub>r</sub>	-	2.2	-	ns	$V_{\rm DD} = 75 \text{ V}, \ V_{\rm GS} = 10 \text{ V}, \ I_{\rm D} = 16 \text{ A}, \ R_{\rm G,ext} = 3 \Omega$	
Turn-off delay time	$t_{ m d(off)}$	-	7.5	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =16 A, $R_{\rm G,ext}$ =3 $\Omega$	
Fall time	t <sub>f</sub>	-	2.2	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =16 A, $R_{\rm G,ext}$ =3 $\Omega$	

Table 6 Gate charge characteristics<sup>2)</sup>

Parameter	Symphol		Values		I Imit	Note / Test Condition	
	Symbol	Min.	Тур.	Max.	Unit		
Gate to source charge	$Q_{gs}$	-	4.3	-	nC	$V_{DD}$ =75 V, $I_{D}$ =16 A, $V_{GS}$ =0 to 10 V	
Gate to drain charge <sup>1)</sup>	$Q_{\mathrm{gd}}$	-	2.2	3.4	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =16 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	Q <sub>sw</sub>	-	4.5	-	nC	$V_{DD}$ =75 V, $I_{D}$ =16 A, $V_{GS}$ =0 to 10 V	
Gate charge total <sup>1)</sup>	Qg	-	10.1	13	nC	$V_{DD}$ =75 V, $I_{D}$ =16 A, $V_{GS}$ =0 to 10 V	
Gate plateau voltage	V <sub>plateau</sub>	-	5.9	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =16 A, $V_{\rm GS}$ =0 to 10 V	
Output charge <sup>1)</sup>	Qoss	-	28	37	nC	V <sub>DD</sub> =75 V, V <sub>GS</sub> =0 V	

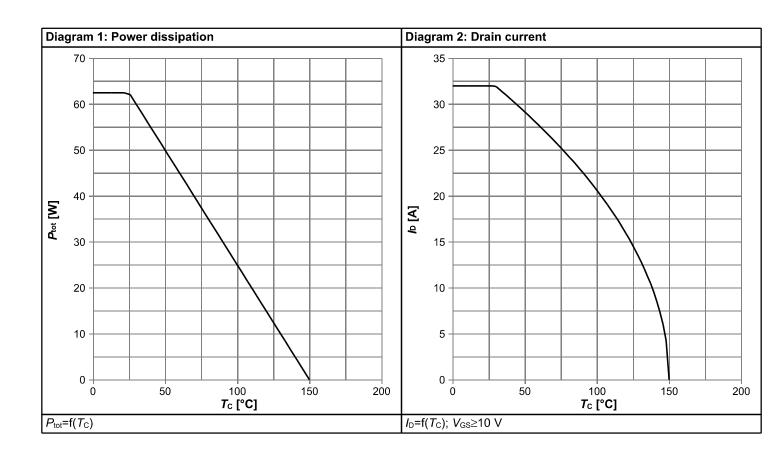
### Table 7 Reverse diode

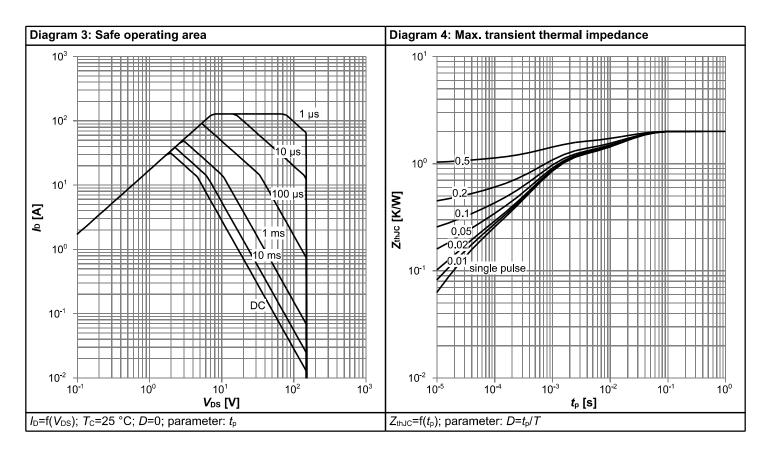
Parameter	Symbol		Values	<b>;</b>	Unit	Note / Test Condition	
raiailietei	Symbol	Min.	Тур.	Max.	Ullit		
Diode continous forward current	Is	-	-	32	Α	T <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	128	Α	T <sub>C</sub> =25 °C	
Diode forward voltage	<b>V</b> <sub>SD</sub>	-	0.88	1.2	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =16 A, T <sub>j</sub> =25 °C	
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	20.5	41	ns	V <sub>R</sub> =75 V, I <sub>F</sub> =16, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	
Reverse recovery charge <sup>1)</sup>	Q <sub>rr</sub>	-	10.9	21.8	nC	$V_R$ =75 V, $I_F$ =16, $di_F/dt$ =100 A/ $\mu$ s	

Defined by design. Not subject to production test See "Gate charge waveforms" for parameter definition

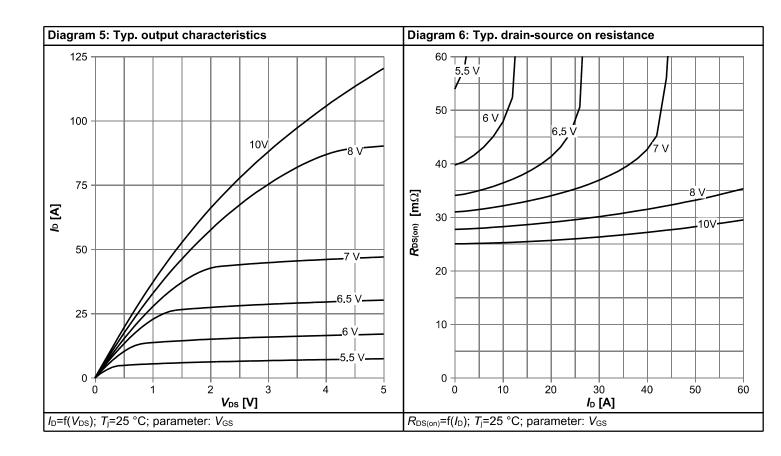


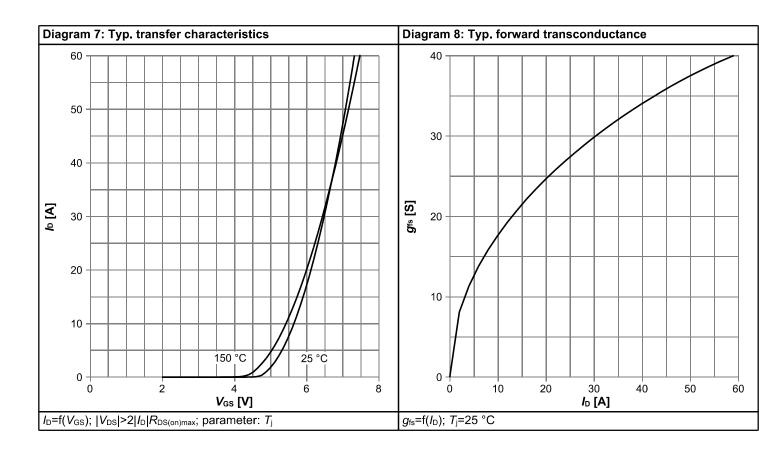
### 4 Electrical characteristics diagrams



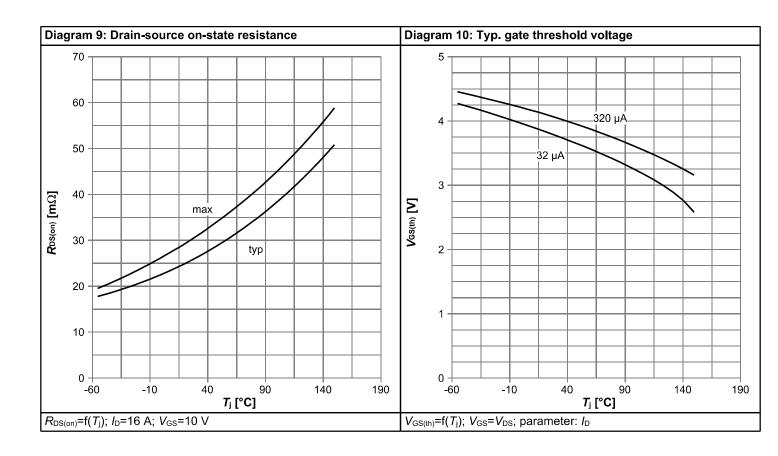


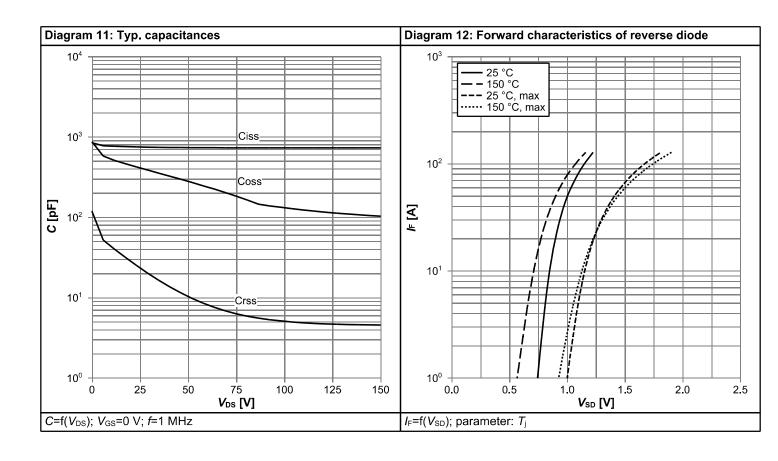




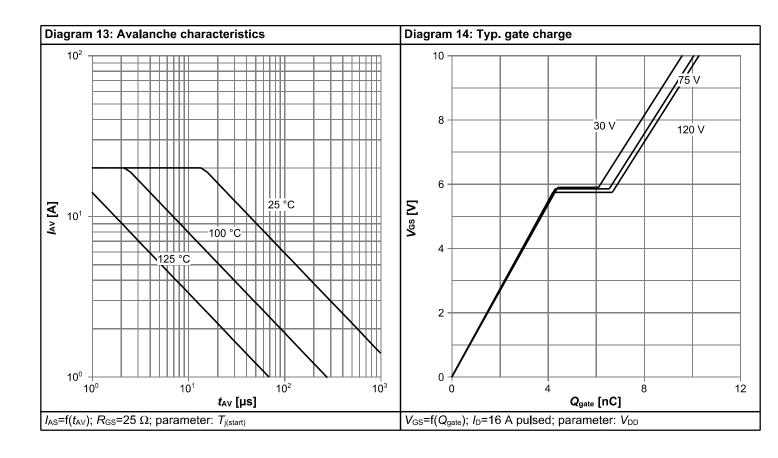


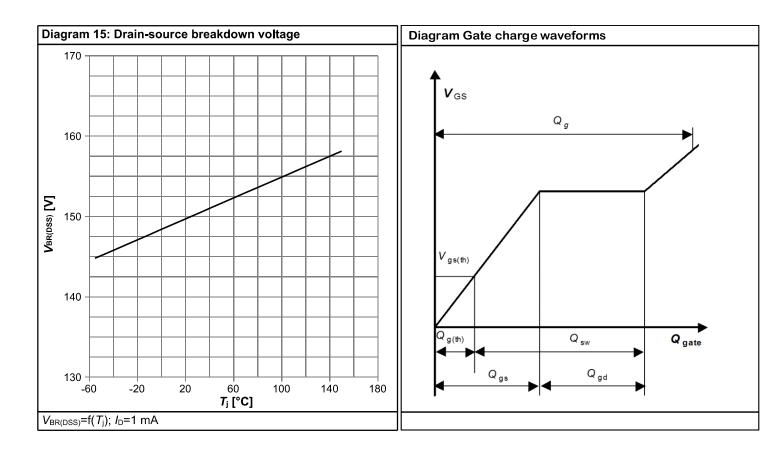






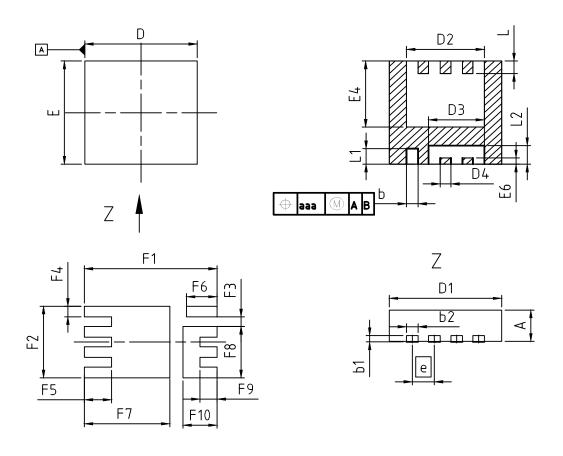








## 5 Package Outlines



DIM r	MILLIN	METERS	INCH	INCHES				
DIIVI	MIN	MAX	MIN	MAX				
Α	0.90	1.10	0.035	0.043				
b	0.24	0.44	0.009	0.017				
b1	0.10	0.30	0.004	0.012				
b2	0.24	0.44	0.009	0.017				
D=D1	3.20	3.40	0.126	0.134				
D2	2.19	2.39	0.086	0.094				
D3	1.54	1.74	0.061	0.069				
D4	0.21	0.41	0.008	0.016				
E	3.20	3.40	0.126	0.134				
E4	2.01	2.21	0.079	0.087				
E6	0.10	0.30	0.004	0.012				
е	0	.65 (BSC)	0.026 (BSC)					
N		8	8					
L	0.30	0.51	0.012	0.020				
L1	0.40	0.70	0.016	0.028				
L2	0.50	0.70	0.020	0.028				
aaa	0.	25	0.0	10				
F1	3.	90	0.154					
F2	2.	29	0.090					
F3	0.	31	0.012					
F4	0.	34	0.013					
F5	0.	80	0.031					
F6	1.0	00	0.039					
F7	2.	51	0.099					
F8	1.0	64	0.0	165				
F9	0.	50	0.0	20				

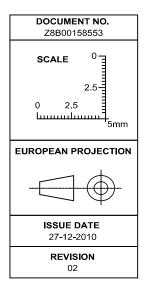


Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm/inches



#### **Revision History**

BSZ300N15NS5

Revision: 2021-06-09, Rev. 2.2

Previous Revision

Treviede ( terrale)						
Revision	Date	Subjects (major changes since last revision)				
2.0	2015-05-27	Release of final version				
2.1	2015-06-09	Update avalanche energy				
2.2	2021-06-09	Update "Marking"				

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